

PATENT APPLICATION  
Attorney Docket No. 2522-11

COMBINED DECLARATION AND POWER OF ATTORNEY  
FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **METHOD OF FORMING A THIN FILM USING ATOMIC LAYER DEPOSITION**, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Sec. 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Sec. 119 (a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed: NONE

I hereby claim the benefit under Title 35, United States Code, Sec. 119(e) of any United States provisional application listed below: NONE

I hereby claim the benefit under Title 35, United States Code, Sec. 120 or §365(c) of any PCT international application designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application: NONE

I hereby appoint the following attorneys to prosecute the application, to file a corresponding international application, to prosecute and transact all business in the Patent and Trademark Office connected therewith:

**\*20575\***

**20575**

PATENT TRADEMARK OFFICE



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PATENT APPLICATION  
Atty's Do. No. 2522-11

**ASSIGNMENT**

U.S.A. Patent Application  
Sole or Joint  
For Inventions Made Outside U.S.A.  
Executed With Application

In consideration of the sum of Ten Dollars (10.00) and other good and valuable considerations paid to each of the undersigned, to wit:

- (1) Yeong-Kwan KIM
- (2) Young-Wook PARK
- (3) Seung-Hwan LEE

☐ X if continued on separate page

the receipt and sufficiency of which are hereby acknowledged by the undersigned who hereby sell(s), assign(s) and transfer(s) unto:

**SAMSUNG ELECTRONICS CO., LTD.**  
**416 MAETAN-DONG, PALDAL-KU**  
**SUWON-CITY, KYUNGKI-DO**  
**REPUBLIC OF KOREA**

(hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States Of America as defined in 35 U.S.C. §1.00, in and to the invention known as:

**METHOD OF FORMING A THIN FILM USING ATOMIC LAYER DEPOSITION**

for which an application for Letters Patent of the United States of America has been executed even date herewith by the undersigned, and in and to any and all divisionals, continuations, substitutes, and reissues thereof; and all resulting patents and the undersigned hereby authorizes and requests the United States Assistant Commissioner of Patents to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

And the undersigned hereby agrees to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE'S full protection and title in and to the invention hereby transferred.

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Please sign  
concurrently  
 with Oath or Declaration  
 and Power of Attorney

SIGNED ON THE DATES INDICATED BESIDE OUR SIGNATURES:

INVENTOR(S)	DATE SIGNED	WITNESSED
(1) <u>Yeong-Kwan Kim</u> Yeong-Kwan KIM	<u>31-May-2001</u>	<u>Joo-Won LEE</u>
(2) <u>Young-Wook PARK</u> Young-Wook PARK	<u>31-May-2001</u>	<u>Eun-Ae Chung</u>
(3) <u>Seung-Hwan LEE</u> Seung-Hwan LEE	<u>31-May-2001</u>	<u>Dong-Chan Kim</u>

FOR ADDITIONAL INVENTORS, "X" BOX ☐ AND CONTINUE ON SEC- 2.005

PLEASE RETURN RECORDED ASSIGNMENT TO:

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